

EXPRESS MAIL LABEL NO. EL443489499US

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

8/9/99

Applicant:

Rengarajan et al.

Examiner:

Tran, T.

Serial No:

09/000,626

Group Art Unit:

2811

Filed:

December 30, 1997

Atty Dkt No.: 97 P 7971 US 02

For:

RECESSED SHALLOW TRENCH

ISOLATION STRUCTURE ...

Date: August 2, 1999

Assistant Commissioner for Patents Washington, D.C. 20231

PRELIMINARY AMENDMENT

RECEIVED
AUG-6 1999
TO 2800 MAIL ROOF

Sir:

Before examination of the above-identified application on the merits, kindly amend the application as follows:

IN THE CLAIMS

Please cancel claims 6, 9 and 11 without prejudice and amend the claims as follows:

1. (Twice Amended) A shallow trench isolation in a substrate, said shallow trench isolation structure comprising:

a trench in said substrate; [and]

a nitride liner recessed within said trench and the nitride liner forming a partially enclosed volume, said partially enclosed volume being completely filled with a dielectric material which also completely fills the trench, such that an uppermost surface of said nitride liner is disposed below a transistor channel depth of a transistor disposed in a well beside said shallow trench isolation structure[.]; and